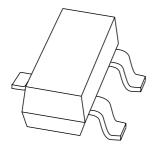
DISCRETE SEMICONDUCTORS

DATA SHEET



BCX19 NPN general purpose transistor

Product data sheet Supersedes data of 2000 Jul 28 2004 Jan 16



NXP Semiconductors Product data sheet

NPN general purpose transistor

BCX19

FEATURES

- High current (500 mA)
- Low voltage (45 V).

APPLICATIONS

- · General purpose amplification
- Saturated switching and driver applications.

DESCRIPTION

NPN transistor in a SOT23 plastic package. PNP complement: BCX17.

MARKING

| TYPE NUMBER | MARKING CODE(1) |
|-------------|-----------------|
| BCX19 | U1* |

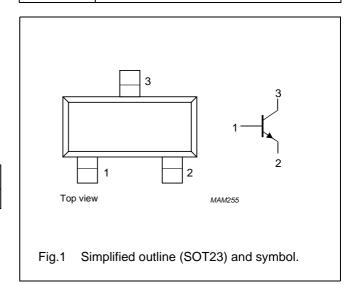
Note

1. * = p: Made in Hong Kong.

* = t : Made in Malaysia. * = W : Made in China.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | base |
| 2 | emitter |
| 3 | collector |



ORDERING INFORMATION

| TYPE | | PACKAGE | | | | |
|--------|------|--|---------|--|--|--|
| NUMBER | NAME | DESCRIPTION | VERSION | | | |
| BCX19 | _ | plastic surface mounted package; 3 leads | SOT23 | | | |

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|-----------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | 50 | V |
| V_{CEO} | collector-emitter voltage | open base; I _C = 10 mA | _ | 45 | V |
| V _{EBO} | emitter-base voltage | open collector | _ | 5 | V |
| I _C | collector current (DC) | | _ | 500 | mA |
| I _{CM} | peak collector current | | _ | 1 | Α |
| I _{BM} | peak base current | | _ | 200 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; note 1 | _ | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | _ | 150 | °C |
| T _{amb} | operating ambient temperature | | -65 | +150 | °C |

Note

1. Transistor mounted on an FR4 printed-circuit board.

NXP Semiconductors Product data sheet

NPN general purpose transistor

BCX19

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|---|------------|-------|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | note 1 | 500 | K/W |

Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

 $T_i = 25$ °C unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------------|--------------------------------------|--|------|------|------|------|
| I _{CBO} | collector cut-off current | I _E = 0; V _{CB} = 20 V | _ | _ | 100 | nA |
| | | I _E = 0; V _{CB} = 20 V; T _j = 150 °C | _ | _ | 5 | μΑ |
| I _{EBO} | emitter cut-off current | I _C = 0; V _{EB} = 5 V | _ | _ | 100 | nA |
| h _{FE} | DC current gain | V _{CE} = 1 V; note 1 | | | | |
| | | I _C = 100 mA | 100 | _ | 600 | |
| | | I _C = 300 mA | 70 | _ | _ | |
| | | I _C = 500 mA | 40 | _ | _ | |
| V _{CEsat} | collector-emitter saturation voltage | $I_C = 500 \text{ mA}; I_B = 50 \text{ mA}; \text{ note 2}$ | _ | _ | 620 | mV |
| V_{BE} | base-emitter voltage | I _C = 500 mA; V _{CE} = 1 V; notes 1 and 2 | _ | _ | 1.2 | V |
| C _c | collector capacitance | I _E = I _e = 0; V _{CB} = 10 V; f = 1 MHz | _ | 5 | _ | pF |
| f _T | transition frequency | I _C = 10 mA; V _{CE} = 5 V; f = 100 MHz | 100 | _ | _ | MHz |

Notes

- 1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$
- 2. V_{BE} decreases by approximately -2 mV/ $^{\circ}$ C with increasing temperature.

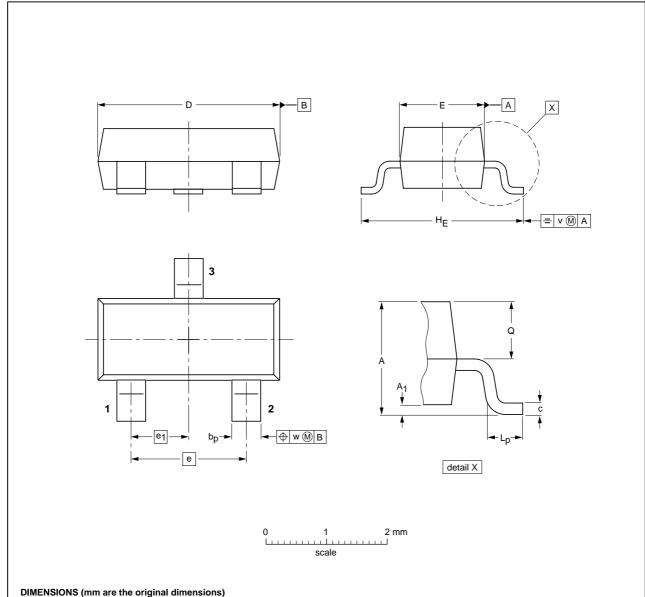
NPN general purpose transistor

BCX19

PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT23



| DIMENS | юмэ (п | ım are tı | ne origir | nai dime | nsions) | |
|--------|--------|-----------|-----------|----------|---------|---|
| | | | | | | _ |

| UNIT | Α | A ₁ max. | bp | С | D | E | е | e ₁ | HE | Lp | Q | v | w |
|------|------------|------------------------|--------------|--------------|------------|------------|-----|----------------|------------|--------------|--------------|-----|-----|
| mm | 1.1 0.9 | 0.1 | 0.48 0.38 | 0.15 0.09 | 3.0 2.8 | 1.4 1.2 | 1.9 | 0.95 | 2.5 2.1 | 0.45 0.15 | 0.55 0.45 | 0.2 | 0.1 |

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|---------|-----|----------|----------|------------|------------|----------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT23 | | TO-236AB | | | | -04-11-04 06-03-16 |

NXP Semiconductors Product data sheet

NPN general purpose transistor

BCX19

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

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